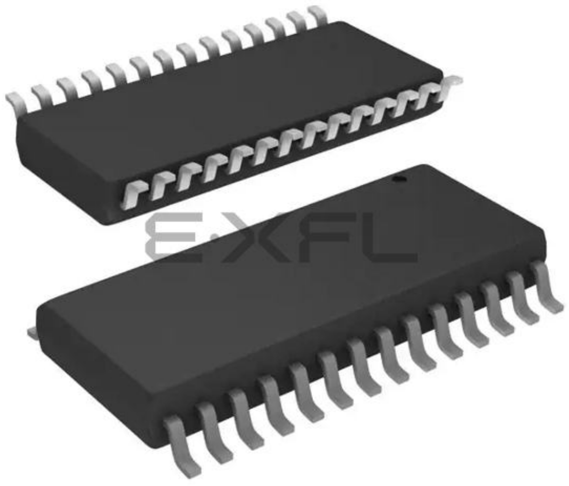
Microchip Technology - PIC18F27J13-I/SO Datasheet



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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	48MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	22
Program Memory Size	128KB (64K x 16)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	3.8K x 8
Voltage - Supply (Vcc/Vdd)	2.15V ~ 3.6V
Data Converters	A/D 10x10b/12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18f27j13-i-so

4.0 LOW-POWER MODES

The PIC18F47J13 Family devices can manage power consumption through clocking to the CPU and the peripherals. In general, reducing the clock frequency and number of circuits being clocked reduces power consumption.

For managing power in an application, the primary modes of operation are:

- Run Mode
- Idle Mode
- Sleep Mode
- Deep Sleep Mode

Additionally, there is an Ultra Low-Power Wake-up (ULPWU) mode for generating an interrupt-on-change on RA0.

These modes define which portions of the device are clocked and at what speed.

- The Run and Idle modes can use any of the three available clock sources (primary, secondary or internal oscillator blocks).
- The Sleep mode does not use a clock source.

The ULPWU mode on RA0 allows a slow falling voltage to generate an interrupt-on-change on RA0 without excess current consumption. See **Section 4.7 "Ultra Low-Power Wake-up"**.

The power-managed modes include several power-saving features offered on previous PIC® devices, such as clock switching, ULPWU and Sleep mode. In addition, the PIC18F47J13 Family devices have added a new power-managed Deep Sleep mode.

4.1 Selecting Power-Managed Modes

Selecting a power-managed mode requires these decisions:

- Will the CPU be clocked?
- If so, which clock source will be used?

The IDLEN bit (OSCCON<7>) controls CPU clocking and the SCS<1:0> bits (OSCCON<1:0>) select the clock source. The individual modes, bit settings, clock sources and affected modules are summarized in Table 4-1.

4.1.1 CLOCK SOURCES

The SCS<1:0> bits allow the selection of one of three clock sources for power-managed modes. They are:

- Primary clock source – Defined by the FOSC<2:0> Configuration bits
- Timer1 clock – Provided by the secondary oscillator
- Postscaled internal clock – Derived from the internal oscillator block

4.1.2 ENTERING POWER-MANAGED MODES

Switching from one clock source to another begins by loading the OSCCON register. The SCS<1:0> bits select the clock source.

Changing these bits causes an immediate switch to the new clock source, assuming that it is running. The switch also may be subject to clock transition delays. These delays are discussed in **Section 4.1.3 "Clock Transitions and Status Indicators"** and subsequent sections.

Entry to the power-managed Idle or Sleep modes is triggered by the execution of a `SLEEP` instruction. The actual mode that results depends on the status of the IDLEN bit.

Depending on the current mode and the mode being switched to, a change to a power-managed mode does not always require setting all of these bits. Many transitions may be done by changing the oscillator select bits, the IDLEN bit or the DSEN bit prior to issuing a `SLEEP` instruction.

If the IDLEN and DSEN bits are already configured correctly, it may only be necessary to perform a `SLEEP` instruction to switch to the desired mode.

6.1.4.2 Return Stack Pointer (STKPTR)

The STKPTR register (Register 6-1) contains the Stack Pointer value, the STKFUL (Stack Full) and the STKUNF (Stack Underflow) status bits. The value of the Stack Pointer can be 0 through 31. The Stack Pointer increments before values are pushed onto the stack and decrements after values are popped off of the stack. On Reset, the Stack Pointer value will be zero. The user may read and write the Stack Pointer value. This feature can be used by a Real-Time Operating System (RTOS) for return stack maintenance.

After the PC is pushed onto the stack 31 times (without popping any values off the stack), the STKFUL bit is set. The STKFUL bit is cleared by software or by a Power-on Reset (POR).

The action that takes place when the stack becomes full depends on the state of the Stack Overflow Reset Enable (STVREN) Configuration bit.

Refer to **Section 27.1 "Configuration Bits"** for the device Configuration bits' description.

If STVREN is set (default), the 31st push will push the (PC + 2) value onto the stack, set the STKFUL bit and reset the device. The STKFUL bit will remain set and the Stack Pointer will be set to zero.

If STVREN is cleared, the STKFUL bit will be set on the 31st push and the Stack Pointer will increment to 31. Any additional pushes will not overwrite the 31st push and the STKPTR will remain at 31.

When the stack has been popped enough times to unload the stack, the next pop will return zero to the PC and set the STKUNF bit, while the Stack Pointer remains at zero. The STKUNF bit will remain set until cleared by software or until a POR occurs.

Note:	Returning a value of zero to the PC on an underflow has the effect of vectoring the program to the Reset vector, where the stack conditions can be verified and appropriate actions can be taken. This is not the same as a Reset, as the contents of the SFRs are not affected.

6.1.4.3 `PUSH` and `POP` Instructions

Since the Top-of-Stack (TOS) is readable and writable, the ability to push values onto the stack and pull values off of the stack, without disturbing normal program execution, is necessary. The PIC18 instruction set includes two instructions, `PUSH` and `POP`, that permit the TOS to be manipulated under software control. TOSU, TOSH and TOSL can be modified to place data or a return address on the stack.

The `PUSH` instruction places the current PC value onto the stack. This increments the Stack Pointer and loads the current PC value onto the stack.

The `POP` instruction discards the current TOS by decrementing the Stack Pointer. The previous value pushed onto the stack then becomes the TOS value.

REGISTER 6-1: STKPTR: STACK POINTER REGISTER (ACCESS FFCh)

R/C-0	R/C-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
STKFUL(1)	STKUNF(1)	—	SP4	SP3	SP2	SP1	SP0
bit 7							bit 0

Legend:	C = Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	**STKFUL:** Stack Full Flag bit(1) 1 = Stack became full or overflowed 0 = Stack has not become full or overflowed
bit 6	**STKUNF:** Stack Underflow Flag bit(1) 1 = Stack underflow occurred 0 = Stack underflow did not occur
bit 5	**Unimplemented**: Read as '0'
bit 4-0	**SP<4:0>:** Stack Pointer Location bits

Note 1: Bits 7 and 6 are cleared by user software or by a POR.

TABLE 6-4: REGISTER FILE SUMMARY (PIC18F47J13 FAMILY) (CONTINUED)

Addr.	File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR
F07h	CCPR8L	Capture/Compare/PWM Register 8 Low Byte								`xxxx xxxx`
F06h	CCP8CON	—	—	DC8B1	DC8B0	CCP8M3	CCP8M2	CCP8M1	CCP8M0	`--00 0000`
F05h	CCPR9H	Capture/Compare/PWM Register 9 High Byte								`xxxx xxxx`
F04h	CCPR9L	Capture/Compare/PWM Register 9 Low Byte								`xxxx xxxx`
F03h	CCP9CON	—	—	DC9B1	DC9B0	CCP9M3	CCP9M2	CCP9M1	CCP9M0	`--00 0000`
F02h	CCPR10H	Capture/Compare/PWM Register 10 High Byte								`xxxx xxxx`
F01h	CCPR10L	Capture/Compare/PWM Register 10 Low Byte								`xxxx xxxx`
F00h	CCP10CON	—	—	DC10B1	DC10B0	CCP10M3	CCP10M2	CCP10M1	CCP10M0	`--00 0000`
EFFh	RPINR24	—	—	—	PWM Fault Input (FLT0) to Input Pin Mapping bits					`---1 1111`
EFEh	RPINR23	—	—	—	SPI2 Slave Select Input ($\overline{\text{SS2}}$) to Input Pin Mapping bits					`---1 1111`
EFDh	RPINR22	—	—	—	SPI2 Clock Input (SCK2) to Input Pin Mapping bits					`---1 1111`
EFCh	RPINR21	—	—	—	SPI2 Data Input (SDI2) to Input Pin Mapping bits					`---1 1111`
EFBh	—	—	—	—	—	—	—	—	—	**(3)**
EFAh	—	—	—	—	—	—	—	—	—	**(3)**
EF9h	—	—	—	—	—	—	—	—	—	**(3)**
EF8h	RPINR17	—	—	—	EUSART2 Clock Input (CK2) to Input Pin Mapping bits					`---1 1111`
EF7h	RPINR16	—	—	—	EUSART2 RX2/DT2 to Input Pin Mapping bits					`---1 1111`
EF6h	—	—	—	—	—	—	—	—	—	**(3)**
EF5h	—	—	—	—	—	—	—	—	—	**(3)**
EF4h	RPINR14	—	—	—	Timer5 Gate Input (T5G) to Input Pin Mapping bits					`---1 1111`
EF3h	RPINR13	—	—	—	Timer3 Gate Input (T3G) to Input Pin Mapping bits					`---1 1111`
EF2h	RPINR12	—	—	—	Timer1 Gate Input (T1G) to Input Pin Mapping bits					`---1 1111`
EF1h	—	—	—	—	—	—	—	—	—	**(3)**
EF0h	—	—	—	—	—	—	—	—	—	**(3)**
EEFh	—	—	—	—	—	—	—	—	—	**(3)**
EEEh	—	—	—	—	—	—	—	—	—	**(3)**
EEDh	—	—	—	—	—	—	—	—	—	**(3)**
EECh	—	—	—	—	—	—	—	—	—	**(3)**
EEBh	—	—	—	—	—	—	—	—	—	**(3)**
EEAh	RPINR9	—	—	—	ECCP3 Input Capture (IC3) to Input Pin Mapping bits					`---1 1111`
EE9h	RPINR8	—	—	—	ECCP2 Input Capture (IC2) to Input Pin Mapping bits					`---1 1111`
EE8h	RPINR7	—	—	—	ECCP1 Input Capture (IC1) to Input Pin Mapping bits					`---1 1111`
EE7h	RPINR15	—	—	—	Timer5 External Clock Input (T5CKI) to Input Pin Mapping bits					`---1 1111`
EE6h	RPINR6	—	—	—	Timer3 External Clock Input (T3CKI) to Input Pin Mapping bits					`---1 1111`
EE5h	—	—	—	—	—	—	—	—	—	**(3)**
EE4h	RPINR4	—	—	—	Timer0 External Clock Input (T0CKI) to Input Pin Mapping bits					`---1 1111`
EE3h	RPINR3	—	—	—	External Interrupt (INT3) to Input Pin Mapping bits					`---1 1111`
EE2h	RPINR2	—	—	—	External Interrupt (INT2) to Input Pin Mapping bits					`---1 1111`
EE1h	RPINR1	—	—	—	External Interrupt (INT1) to Input Pin Mapping bits					`---1 1111`
EE0h	—	—	—	—	—	—	—	—	—	**(3)**
EDFh	—	—	—	—	—	—	—	—	—	**(3)**
EDEh	—	—	—	—	—	—	—	—	—	**(3)**
EDDh	—	—	—	—	—	—	—	—	—	**(3)**
EDCh	—	—	—	—	—	—	—	—	—	**(3)**
EDBh	—	—	—	—	—	—	—	—	—	**(3)**
EDAh	—	—	—	—	—	—	—	—	—	**(3)**
ED9h	—	—	—	—	—	—	—	—	—	**(3)**
ED8h	RPOR24(2)	—	—	—	Remappable Pin RP24 Output Signal Select bits					`---0 0000`
ED7h	RPOR23(2)	—	—	—	Remappable Pin RP23 Output Signal Select bits					`---0 0000`

Note 1: Applicable for 28-pin devices (PIC18F26J13, PIC18F27J13, PIC18LF26J13 and PIC18LF27J13).
2: Applicable for 44-pin devices (PIC18F46J13, PIC18F47J13, PIC18LF46J13 and PIC18LF47J13).
3: Value on POR, BOR.

Example 8-3 provides the instruction sequence for a 16 x 16 unsigned multiplication. Equation 8-1 provides the algorithm that is used. The 32-bit result is stored in four registers (RES3:RES0).

EQUATION 8-1: 16 x 16 UNSIGNED MULTIPLICATION ALGORITHM

$$\begin{aligned} RES3{:}RES0 &= ARG1H{:}ARG1L \cdot ARG2H{:}ARG2L \\ &= (ARG1H \cdot ARG2H \cdot 2^{16}) + \\ &\quad (ARG1H \cdot ARG2L \cdot 2^{8}) + \\ &\quad (ARG1L \cdot ARG2H \cdot 2^{8}) + \\ &\quad (ARG1L \cdot ARG2L) \end{aligned}$$

EXAMPLE 8-3: 16 x 16 UNSIGNED MULTIPLY ROUTINE

```
    MOVF    ARG1L, W
    MULWF   ARG2L           ; ARG1L * ARG2L->
                            ; PRODH:PRODL
    MOVFF   PRODH, RES1     ;
    MOVFF   PRODL, RES0     ;

    MOVF    ARG1H, W
    MULWF   ARG2H           ; ARG1H * ARG2H->
                            ; PRODH:PRODL
    MOVFF   PRODH, RES3     ;
    MOVFF   PRODL, RES2     ;

    MOVF    ARG1L, W
    MULWF   ARG2H           ; ARG1L * ARG2H->
                            ; PRODH:PRODL
    MOVF    PRODL, W        ;
    ADDWF   RES1, F         ; Add cross
    MOVF    PRODH, W        ; products
    ADDWFC  RES2, F         ;
    CLRF    WREG            ;
    ADDWFC  RES3, F         ;

    MOVF    ARG1H, W        ;
    MULWF   ARG2L           ; ARG1H * ARG2L->
                            ; PRODH:PRODL
    MOVF    PRODL, W        ;
    ADDWF   RES1, F         ; Add cross
    MOVF    PRODH, W        ; products
    ADDWFC  RES2, F         ;
    CLRF    WREG            ;
    ADDWFC  RES3, F         ;
```

Example 8-4 provides the sequence to do a 16 x 16 signed multiply. Equation 8-2 provides the algorithm used. The 32-bit result is stored in four registers (RES3:RES0). To account for the sign bits of the arguments, the MSb for each argument pair is tested and the appropriate subtractions are done.

EQUATION 8-2: 16 x 16 SIGNED MULTIPLICATION ALGORITHM

$$\begin{aligned} RES3{:}RES0 &= ARG1H{:}ARG1L \cdot ARG2H{:}ARG2L \\ &= (ARG1H \cdot ARG2H \cdot 2^{16}) + \\ &\quad (ARG1H \cdot ARG2L \cdot 2^{8}) + \\ &\quad (ARG1L \cdot ARG2H \cdot 2^{8}) + \\ &\quad (ARG1L \cdot ARG2L) + \\ &\quad (-1 \cdot ARG2H{<}7{>} \cdot ARG1H{:}ARG1L \cdot 2^{16}) + \\ &\quad (-1 \cdot ARG1H{<}7{>} \cdot ARG2H{:}ARG2L \cdot 2^{16}) \end{aligned}$$

EXAMPLE 8-4: 16 x 16 SIGNED MULTIPLY ROUTINE

```
    MOVF    ARG1L, W
    MULWF   ARG2L           ; ARG1L * ARG2L ->
                            ; PRODH:PRODL
    MOVFF   PRODH, RES1     ;
    MOVFF   PRODL, RES0     ;

    MOVF    ARG1H, W
    MULWF   ARG2H           ; ARG1H * ARG2H ->
                            ; PRODH:PRODL
    MOVFF   PRODH, RES3     ;
    MOVFF   PRODL, RES2     ;

    MOVF    ARG1L, W
    MULWF   ARG2H           ; ARG1L * ARG2H ->
                            ; PRODH:PRODL
    MOVF    PRODL, W        ;
    ADDWF   RES1, F         ; Add cross
    MOVF    PRODH, W        ; products
    ADDWFC  RES2, F         ;
    CLRF    WREG            ;
    ADDWFC  RES3, F         ;

    MOVF    ARG1H, W        ;
    MULWF   ARG2L           ; ARG1H * ARG2L ->
                            ; PRODH:PRODL
    MOVF    PRODL, W        ;
    ADDWF   RES1, F         ; Add cross
    MOVF    PRODH, W        ; products
    ADDWFC  RES2, F         ;
    CLRF    WREG            ;
    ADDWFC  RES3, F         ;

    BTFSS   ARG2H, 7        ; ARG2H:ARG2L neg?
    BRA     SIGN_ARG1       ; no, check ARG1
    MOVF    ARG1L, W        ;
    SUBWF   RES2            ;
    MOVF    ARG1H, W        ;
    SUBWFB  RES3

SIGN_ARG1
    BTFSS   ARG1H, 7        ; ARG1H:ARG1L neg?
    BRA     CONT_CODE       ; no, done
    MOVF    ARG2L, W        ;
    SUBWF   RES2            ;
    MOVF    ARG2H, W        ;
    SUBWFB  RES3

CONT_CODE
   :
```

REGISTER 9-5: PIR2: PERIPHERAL INTERRUPT REQUEST (FLAG) REGISTER 2 (ACCESS FA1h)

R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
OSCFIF	CM2IF	CM1IF	—	BCL1IF	HLVDIF	TMR3IF	CCP2IF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7 **OSCFIF:** Oscillator Fail Interrupt Flag bit
1 = The device oscillator failed, clock input has changed to INTOSC (must be cleared in software)
0 = The device clock operating

bit 6 **CM2IF:** Comparator 2 Interrupt Flag bit
1 = The comparator input has changed (must be cleared in software)
0 = The comparator input has not changed

bit 5 **CM1IF:** Comparator 1 Interrupt Flag bit
1 = The comparator input has changed (must be cleared in software)
0 = The comparator input has not changed

bit 4 **Unimplemented:** Read as ‘0’

bit 3 **BCL1IF:** Bus Collision Interrupt Flag bit (MSSP1 module)
1 = A bus collision occurred (must be cleared in software)
0 = No bus collision occurred

bit 2 **HLVDIF:** High/Low-Voltage Detect (HLVD) Interrupt Flag bit
1 = A High/Low-Voltage condition occurred (must be cleared in software)
0 = An HLVD event has not occurred

bit 1 **TMR3IF:** TMR3 Overflow Interrupt Flag bit
1 = The TMR3 register overflowed (must be cleared in software)
0 = The TMR3 register did not overflow

bit 0 **CCP2IF:** ECCP2 Interrupt Flag bit
Capture mode:
1 = A TMR1/TMR3 register capture occurred (must be cleared in software)
0 = No TMR1/TMR3 register capture occurred
Compare mode:
1 = A TMR1/TMR3 register compare match occurred (must be cleared in software)
0 = No TMR1/TMR3 register compare match occurred
PWM mode:
Unused in this mode.

REGISTER 9-8: PIR5: PERIPHERAL INTERRUPT REQUEST (FLAG) REGISTER 5 (ACCESS F98h)

U-0	U-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	CM3IF	TMR8IF	TMR6IF	TMR5IF	TMR5GIF	TMR1GIF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7-6	**Unimplemented:** Read as ‘0’
bit 5	**CM3IF:** Comparator Interrupt Flag bit 1 = Comparator 3 input has changed (must be cleared in software) 0 = Comparator 3 input has not changed
bit 4	**TMR8IF:** TMR8 to PR8 Match Interrupt Flag bit 1 = TMR8 to PR8 match occurred (must be cleared in software) 0 = No TMR8 to PR8 match occurred
bit 3	**TMR6IF:** TMR6 to PR6 Match Interrupt Flag bit 1 = TMR6 to PR6 match occurred (must be cleared in software) 0 = No TMR6 to PR6 match occurred
bit 2	**TMR5IF:** TMR3 Overflow Interrupt Flag bit 1 = TMR3 register overflowed (must be cleared in software) 0 = TMR3 register did not overflow
bit 1	**TMR5GIF:** TMR5 Gate Interrupt Flag bits 1 = TMR gate interrupt occurred (must be cleared in software) 0 = No TMR gate interrupt occurred
bit 0	**TMR1GIF:** TMR5 Gate Interrupt Flag bits 1 = TMR gate interrupt occurred (must be cleared in software) 0 = No TMR gate interrupt occurred

10.7 Peripheral Pin Select (PPS)

A major challenge in general purpose devices is providing the largest possible set of peripheral features while minimizing the conflict of features on I/O pins. The challenge is even greater on low pin count devices similar to the PIC18F47J13 Family. In an application that needs to use more than one peripheral, multiplexed on a single pin, inconvenient work arounds in application code or a complete redesign may be the only option.

The Peripheral Pin Select (PPS) feature provides an alternative to these choices by enabling the user's peripheral set selection and its placement on a wide range of I/O pins. By increasing the pinout options available on a particular device, users can better tailor the microcontroller to their entire application, rather than trimming the application to fit the device.

The PPS feature operates over a fixed subset of digital I/O pins. Users may independently map the input and/or output of any one of the many digital peripherals to any one of these I/O pins. PPS is performed in software, and generally, does not require the device to be reprogrammed. Hardware safeguards are included that prevent accidental or spurious changes to the peripheral mapping once it has been established.

10.7.1 AVAILABLE PINS

The PPS feature is used with a range of up to 22 pins. The number of available pins is dependent on the particular device and its pin count. Pins that support the PPS feature include the designation "RPn" in their full pin designation, where "RP" designates a remappable peripheral and "n" is the remappable pin number. See Table 1-3 and Table 1-4 for pinout options in each package offering.

10.7.2 AVAILABLE PERIPHERALS

The peripherals managed by the PPS are all digital only peripherals. These include general serial communications (UART and SPI), general purpose timer clock inputs, timer-related peripherals (input capture and output compare) and external interrupt inputs. Also included are the outputs of the comparator module, since these are discrete digital signals.

The PPS module is not applied to I^2C, change notification inputs, RTCC alarm outputs or peripherals with analog inputs. Additionally, the MSSP1 and EUSART1 modules are not routed through the PPS module.

A key difference between pin select and non-pin select peripherals is that pin select peripherals are not associated with a default I/O pin. The peripheral must always be assigned to a specific I/O pin before it can be used. In contrast, non-pin select peripherals are always available on a default pin, assuming that the peripheral is active and not conflicting with another peripheral.

10.7.2.1 Peripheral Pin Select Function Priority

When a pin selectable peripheral is active on a given I/O pin, it takes priority over all other digital I/O and digital communication peripherals associated with the pin. Priority is given regardless of the type of peripheral that is mapped. Pin select peripherals never take priority over any analog functions associated with the pin.

10.7.3 CONTROLLING PERIPHERAL PIN SELECT

PPS features are controlled through two sets of Special Function Registers (SFRs): one to map peripheral inputs and the other to map outputs. Because they are separately controlled, a particular peripheral's input and output (if the peripheral has both) can be placed on any selectable function pin without constraint.

The association of a peripheral to a peripheral selectable pin is handled in two different ways, depending on whether an input or an output is being mapped.

11.2 Slave Port Modes

The primary mode of operation for the module is configured using the MODE<1:0> bits in the PMMODEH register. The setting affects whether the module acts as a slave or a master and it determines the usage of the control pins.

11.2.1 LEGACY MODE (PSP)

In Legacy mode (PMMODEH<1:0> = 00 and PMPEN = 1), the module is configured as a Parallel Slave Port (PSP) with the associated enabled module pins dedicated to the module. In this mode, an external device, such as another microcontroller or microprocessor, can asynchronously read and write data using the 8-bit data bus (PMD<7:0>), the read (PMRD), write (PMWR) and chip select (PMCS) inputs. It acts as a slave on the bus and responds to the read/write control signals.

Figure 11-2 displays the connection of the PSP. When chip select is active and a write strobe occurs (PMCS = 1 and PMWR = 1), the data from PMD<7:0> is captured into the PMDIN1L register.

FIGURE 11-2: LEGACY PARALLEL SLAVE PORT EXAMPLE

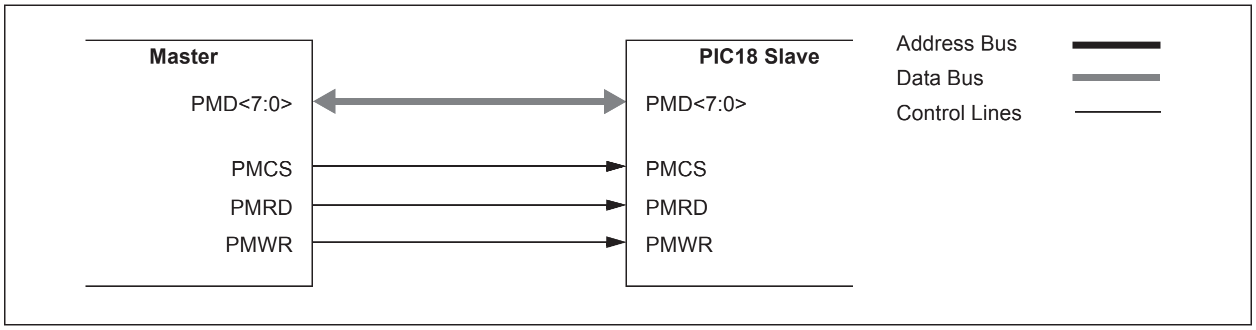


FIGURE 11-24: WRITE TIMING, 16-BIT MULTIPLEXED DATA, PARTIALLY MULTIPLEXED ADDRESS

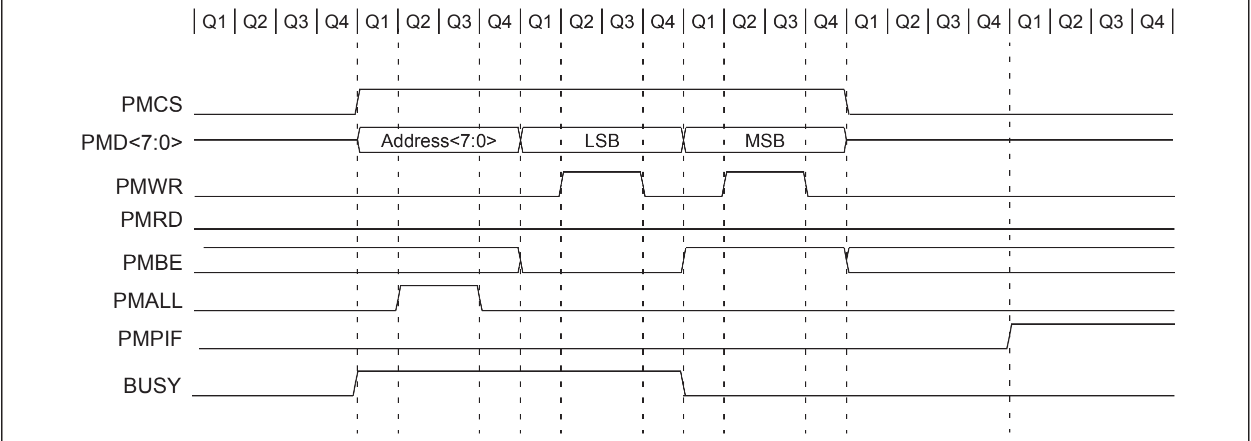

Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4
PMCS
PMD<7:0>
Address<7:0>
LSB
MSB
PMWR
PMRD
PMBE
PMALL
PMPIF
BUSY

FIGURE 11-25: READ TIMING, 16-BIT MULTIPLEXED DATA, FULLY MULTIPLEXED 16-BIT ADDRESS

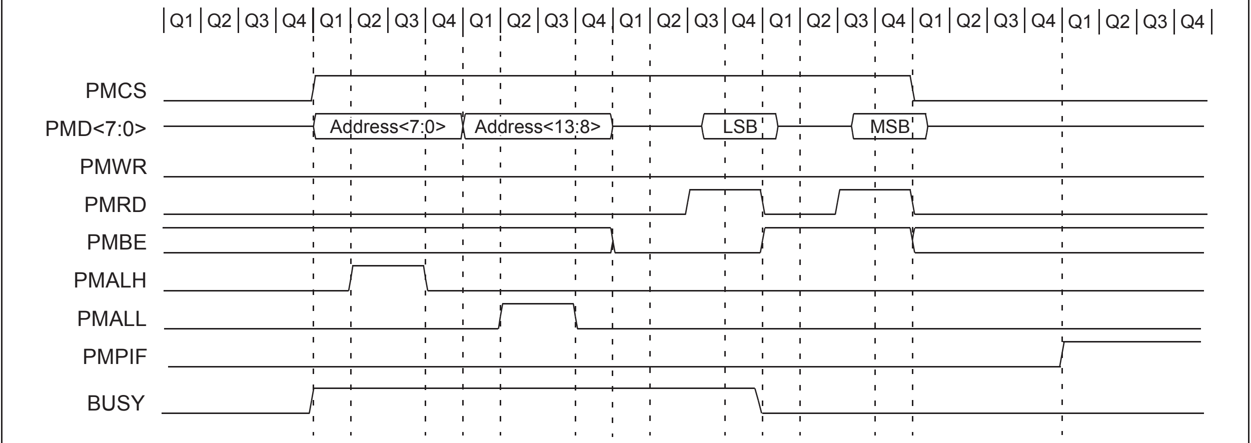
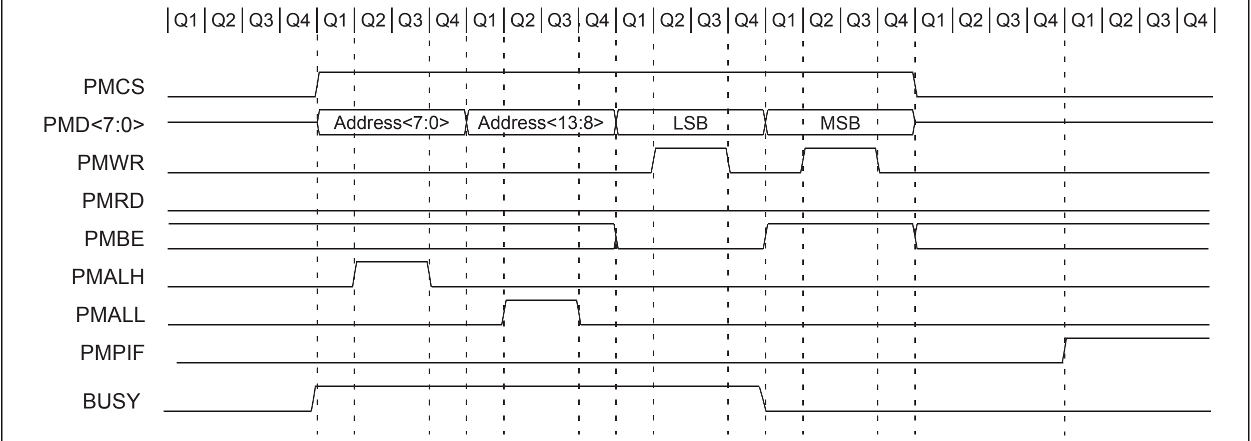

Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4
PMCS
PMD<7:0>
Address<7:0>
Address<13:8>
LSB
MSB
PMWR
PMRD
PMBE
PMALH
PMALL
PMPIF
BUSY

FIGURE 11-26: WRITE TIMING, 16-BIT MULTIPLEXED DATA, FULLY MULTIPLEXED 16-BIT ADDRESS


Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4
PMCS
PMD<7:0>
Address<7:0>
Address<13:8>
LSB
MSB
PMWR
PMRD
PMBE
PMALH
PMALL
PMPIF
BUSY

NOTES:

REGISTER 20-3: DMACON1: DMA CONTROL REGISTER 1 (ACCESS F88h)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
SSCON1	SSCON0	TXINC	RXINC	DUPLEX1	DUPLEX0	DLYINTEN	DMAEN
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7-6 **SSCON<1:0>:** $\overline{\text{SSDMA}}$ Output Control bits (Master modes only)
11 = $\overline{\text{SSDMA}}$ is asserted for the duration of 4 bytes; DLYINTEN is always reset low
01 = $\overline{\text{SSDMA}}$ is asserted for the duration of 2 bytes; DLYINTEN is always reset low
10 = $\overline{\text{SSDMA}}$ is asserted for the duration of 1 byte; DLYINTEN is always reset low
00 = $\overline{\text{SSDMA}}$ is not controlled by the DMA module; the DLYINTEN bit is software programmable

bit 5 **TXINC:** Transmit Address Increment Enable bit
Allows the transmit address to increment as the transfer progresses.
1 = The transmit address is to be incremented from the initial value of TXADDR<11:0>
0 = The transmit address is always set to the initial value of TXADDR<11:0>

bit 4 **RXINC:** Receive Address Increment Enable bit
Allows the receive address to increment as the transfer progresses.
1 = The received address is to be incremented from the initial value of RXADDR<11:0>
0 = The received address is always set to the initial value of RXADDR<11:0>

bit 3-2 **DUPLEX<1:0>:** Transmit/Receive Operating Mode Select bits
10 = SPI DMA operates in Full-Duplex mode; data is simultaneously transmitted and received
01 = DMA operates in Half-Duplex mode; data is transmitted only
00 = DMA operates in Half-Duplex mode; data is received only

bit 1 **DLYINTEN:** Delay Interrupt Enable bit
Enables the interrupt to be invoked after the number of T_{CY} cycles specified in DLYCYC<2:0> has elapsed from the latest completed transfer.
1 = The interrupt is enabled; SSCON<1:0> must be set to ‘00’
0 = The interrupt is disabled

bit 0 **DMAEN:** DMA Operation Start/Stop bit
This bit is set by the users’ software to start the DMA operation. It is reset back to zero by the DMA engine when the DMA operation is completed or aborted.
1 = DMA is in session
0 = DMA is not in session

20.5.7.1 Baud Rate and Module Interdependence

Because MSSP1 and MSSP2 are independent, they can operate simultaneously in I^{2}C Master mode at different baud rates. This is done by using different BRG reload values for each module.

Because this mode derives its basic clock source from the system clock, any changes to the clock will affect both modules in the same proportion. It may be possible to change one or both baud rates back to a previous value by changing the BRG reload value.

FIGURE 20-19: BAUD RATE GENERATOR BLOCK DIAGRAM

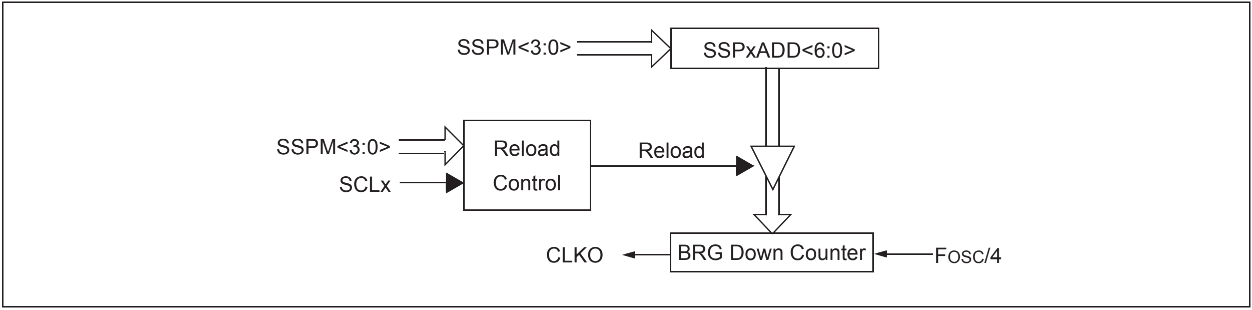


TABLE 20-3: I^{2}C CLOCK RATE w/BRG

FOSC	FCY	FCY * 2	BRG Value	FSCL (2 Rollovers of BRG)
40 MHz	10 MHz	20 MHz	18h	400 kHz
40 MHz	10 MHz	20 MHz	1Fh	312.5 kHz
40 MHz	10 MHz	20 MHz	63h	100 kHz
16 MHz	4 MHz	8 MHz	09h	400 kHz
16 MHz	4 MHz	8 MHz	0Ch	308 kHz
16 MHz	4 MHz	8 MHz	27h	100 kHz
4 MHz	1 MHz	2 MHz	02h	333 kHz
4 MHz	1 MHz	2 MHz	09h	100 kHz
16 MHz	4 MHz	8 MHz	03h	1 MHz(1)

Note 1: The I^{2}C interface does not conform to the 400 kHz I^{2}C specification (which applies to rates greater than 100 kHz) in all details, but may be used with care where higher rates are required by the application.

21.3.2 EUSART SYNCHRONOUS MASTER RECEPTION

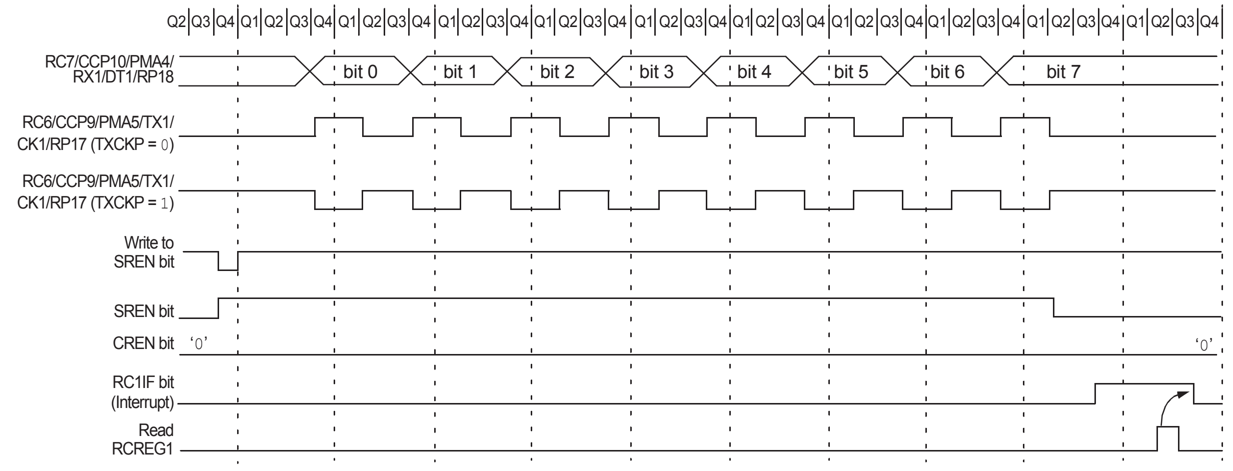
Once Synchronous mode is selected, reception is enabled by setting either the Single Receive Enable bit, SREN (RCSTAx<5>), or the Continuous Receive Enable bit, CREN (RCSTAx<4>). Data is sampled on the RXx pin on the falling edge of the clock.

If enable bit, SREN, is set, only a single word is received. If enable bit, CREN, is set, the reception is continuous until CREN is cleared. If both bits are set, then CREN takes precedence.

To set up a Synchronous Master Reception:

1. Initialize the SPBRGHx:SPBRGx registers for the appropriate baud rate. Set or clear the BRG16 bit, as required, to achieve the desired baud rate.
2. Enable the synchronous master serial port by setting bits, SYNC, SPEN and CSRC.
3. Ensure bits, CREN and SREN, are clear.
4. If interrupts are desired, set enable bit, RCxIE.
5. If 9-bit reception is desired, set bit, RX9.
6. If a single reception is required, set bit, SREN. For continuous reception, set bit, CREN.
7. Interrupt flag bit, RCxIF, will be set when reception is complete and an interrupt will be generated if the enable bit, RCxIE, was set.
8. Read the RCSTAx register to get the ninth bit (if enabled) and determine if any error occurred during reception.
9. Read the 8-bit received data by reading the RCREGx register.
10. If any error occurred, clear the error by clearing bit, CREN.
11. If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

FIGURE 21-13: SYNCHRONOUS RECEPTION (MASTER MODE, SREN)


Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4 Q1 Q2 Q3 Q4
RC7/CCP10/PMA4/RX1/DT1/RP18
bit 0
bit 1
bit 2
bit 3
bit 4
bit 5
bit 6
bit 7
RC6/CCP9/PMA5/TX1/CK1/RP17 (TXCKP = 0)
RC6/CCP9/PMA5/TX1/CK1/RP17 (TXCKP = 1)
Write to SREN bit
SREN bit
CREN bit
'0'
'0'
RC1IF bit (Interrupt)
Read RCREG1

Note: Timing diagram demonstrates Sync Master mode with bit, SREN = 1, and bit, BRGH = 0. This example is equally applicable to EUSART2 (RPn1/TX2/CK2 and RPn2/RX2/DT2).

27.4 Two-Speed Start-up

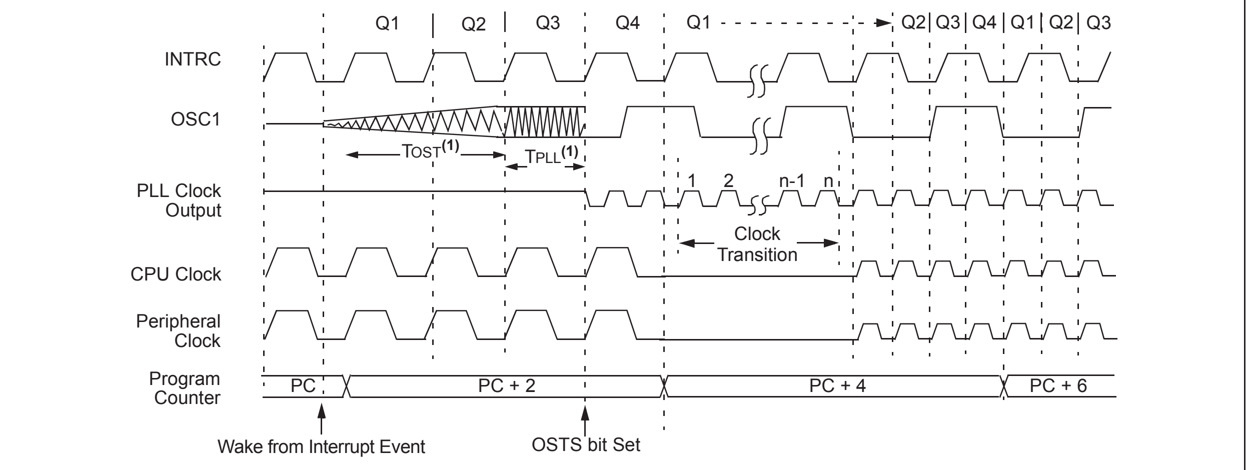
The Two-Speed Start-up feature helps to minimize the latency period, from oscillator start-up to code execution, by allowing the microcontroller to use the INTRC oscillator as a clock source until the primary clock source is available. It is enabled by setting the IESO Configuration bit.

Two-Speed Start-up should be enabled only if the primary oscillator mode is HS or HSPLL (Crystal-Based) modes. Since the EC and ECPLL modes do not require an Oscillator Start-up Timer (OST) delay, Two-Speed Start-up should be disabled.

When enabled, Resets and wake-ups from Sleep mode cause the device to configure itself to run from the internal oscillator block as the clock source, following the time-out of the Power-up Timer after a Power-on Reset is enabled. This allows almost immediate code execution while the primary oscillator starts and the OST is running. Once the OST times out, the device automatically switches to PRI_RUN mode.

In all other power-managed modes, Two-Speed Start-up is not used. The device will be clocked by the currently selected clock source until the primary clock source becomes available. The setting of the IESO bit is ignored.

FIGURE 27-3: TIMING TRANSITION FOR TWO-SPEED START-UP (INTRC TO HSPLL)



Note 1: TOST = 1024 TOSC; TPLL = 2 ms (approx). These intervals are not shown to scale.

27.4.1 SPECIAL CONSIDERATIONS FOR USING TWO-SPEED START-UP

While using the INTRC oscillator in Two-Speed Start-up, the device still obeys the normal command sequences for entering power-managed modes, including serial `SLEEP` instructions (refer to **Section 4.1.4 "Multiple Sleep Commands"**). In practice, this means that user code can change the SCS<1:0> bit settings or issue `SLEEP` instructions before the OST times out. This would allow an application to briefly wake-up, perform routine "housekeeping" tasks and return to Sleep before the device starts to operate from the primary oscillator.

User code can also check if the primary clock source is currently providing the device clocking by checking the status of the OSTS bit (OSCCON<3>). If the bit is set, the primary oscillator is providing the clock. Otherwise, the internal oscillator block is providing the clock during wake-up from Reset or Sleep mode.

27.5 Fail-Safe Clock Monitor

The Fail-Safe Clock Monitor (FSCM) allows the microcontroller to continue operation in the event of an external oscillator failure by automatically switching the device clock to the internal oscillator block. The FSCM function is enabled by setting the FCMEN Configuration bit.

When FSCM is enabled, the INTRC oscillator runs at all times to monitor clocks to peripherals and provide a backup clock in the event of a clock failure. Clock monitoring (shown in Figure 27-4) is accomplished by creating a sample clock signal, which is the INTRC output divided by 64. This allows ample time between FSCM sample clocks for a peripheral clock edge to occur. The peripheral device clock and the sample clock are presented as inputs to the clock monitor latch. The clock monitor is set on the falling edge of the device clock source but cleared on the rising edge of the sample clock.

TABLE 28-1: OPCODE FIELD DESCRIPTIONS

Field	Description
a	RAM Access bit: a = 0: RAM location in Access RAM (BSR register is ignored) a = 1: RAM bank is specified by BSR register
bbb	Bit address within an 8-bit file register (0 to 7).
BSR	Bank Select Register. Used to select the current RAM bank.
C, DC, Z, OV, N	ALU Status bits: **C**arry, **D**igit **C**arry, **Z**ero, **Ov**erflow, **N**egative.
d	Destination Select bit: d = 0: store result in WREG d = 1: store result in file register f
dest	Destination: either the WREG register or the specified register file location.
f	8-bit Register file address (00h to FFh), or 2-bit FSR designator (0h to 3h).
f_s	12-bit Register file address (000h to FFFh). This is the source address.
f_d	12-bit Register file address (000h to FFFh). This is the destination address.
GIE	Global Interrupt Enable bit.
k	Literal field, constant data or label (may be either an 8-bit, 12-bit or a 20-bit value).
label	Label name.
mm * *+ *- +*	The mode of the TBLPTR register for the table read and table write instructions. Only used with table read and table write instructions: No change to register (such as TBLPTR with table reads and writes) Post-Increment register (such as TBLPTR with table reads and writes) Post-Decrement register (such as TBLPTR with table reads and writes) Pre-Increment register (such as TBLPTR with table reads and writes)
n	The relative address (2's complement number) for relative branch instructions or the direct address for Call/Branch and Return instructions.
PC	Program Counter.
PCL	Program Counter Low Byte.
PCH	Program Counter High Byte.
PCLATH	Program Counter High Byte Latch.
PCLATU	Program Counter Upper Byte Latch.
$\overline{\text{PD}}$	Power-Down bit.
PRODH	Product of Multiply High Byte.
PRODL	Product of Multiply Low Byte.
s	Fast Call/Return Mode Select bit: s = 0: do not update into/from shadow registers s = 1: certain registers loaded into/from shadow registers (Fast mode)
TBLPTR	21-bit Table Pointer (points to a program memory location).
TABLAT	8-bit Table Latch.
$\overline{\text{TO}}$	Time-out bit.
TOS	Top-of-Stack.
u	Unused or Unchanged.
WDT	Watchdog Timer.
WREG	Working register (accumulator).
x	Don't care ('0' or '1'). The assembler will generate code with x = 0. It is the recommended form of use for compatibility with all Microchip software tools.
z_s	7-bit offset value for Indirect Addressing of register files (source).
z_d	7-bit offset value for Indirect Addressing of register files (destination).
{ }	Optional argument.
[text]	Indicates an Indexed Address.
(text)	The contents of text.
[expr]<n>	Specifies bit n of the register indicated by the pointer expr.
$\rightarrow$	Assigned to.
< >	Register bit field.
$\in$	In the set of.
italics	User-defined term (font is Courier New).

CALLW	**Subroutine Call Using WREG**
Syntax:	CALLW
Operands:	None
Operation:	(PC + 2) $\rightarrow$ TOS, (W) $\rightarrow$ PCL, (PCLATH) $\rightarrow$ PCH, (PCLATU) $\rightarrow$ PCU
Status Affected:	None
Encoding:	`0000` `0000` `0001` `0100`
Description	First, the return address (PC + 2) is pushed onto the return stack. Next, the contents of W are written to PCL; the existing value is discarded. Then, the contents of PCLATH and PCLATU are latched into PCH and PCU, respectively. The second cycle is executed as a `NOP` instruction while the new next instruction is fetched. Unlike `CALL`, there is no option to update W, STATUS or BSR.
Words:	1
Cycles:	2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read WREG	Push PC to stack	No operation
No operation	No operation	No operation	No operation

Example: `HERE    CALLW`

Before Instruction

PC	=	address `(HERE)`
PCLATH	=	10h
PCLATU	=	00h
W	=	06h

After Instruction

PC	=	001006h
TOS	=	address `(HERE + 2)`
PCLATH	=	10h
PCLATU	=	00h
W	=	06h

MOVSF	**Move Indexed to f**
Syntax:	MOVSF [z_s], f_d
Operands:	$0 \le z_s \le 127$ $0 \le f_d \le 4095$
Operation:	((FSR2) + z_s) $\rightarrow f_d$
Status Affected:	None

Encoding:				
1st word (source)	`1110`	`1011`	`0zzz`	`zzzz`$_s$
2nd word (destin.)	`1111`	`ffff`	`ffff`	`ffff`$_d$

Description: The contents of the source register are moved to destination register 'f_d'. The actual address of the source register is determined by adding the 7-bit literal offset 'z_s', in the first word, to the value of FSR2. The address of the destination register is specified by the 12-bit literal 'f_d' in the second word. Both addresses can be anywhere in the 4096-byte data space (000h to FFFh).

The `MOVSF` instruction cannot use the PCL, TOSU, TOSH or TOSL as the destination register.

If the resultant source address points to an Indirect Addressing register, the value returned will be 00h.

Words: 2

Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Determine source addr	Determine source addr	Read source reg
Decode	No operation No dummy read	No operation	Write register 'f' (dest)

Example: `MOVSF   [0x05], REG2`

Before Instruction

FSR2	=	80h
Contents of 85h	=	33h
REG2	=	11h

After Instruction

FSR2	=	80h
Contents of 85h	=	33h
REG2	=	33h

29.2 MPLAB XC Compilers

The MPLAB XC Compilers are complete ANSI C compilers for all of Microchip's 8, 16, and 32-bit MCU and DSC devices. These compilers provide powerful integration capabilities, superior code optimization and ease of use. MPLAB XC Compilers run on Windows, Linux or MAC OS X.

For easy source level debugging, the compilers provide debug information that is optimized to the MPLAB X IDE.

The free MPLAB XC Compiler editions support all devices and commands, with no time or memory restrictions, and offer sufficient code optimization for most applications.

MPLAB XC Compilers include an assembler, linker and utilities. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. MPLAB XC Compiler uses the assembler to produce its object file. Notable features of the assembler include:

- Support for the entire device instruction set
- Support for fixed-point and floating-point data
- Command-line interface
- Rich directive set
- Flexible macro language
- MPLAB X IDE compatibility

29.3 MPASM Assembler

The MPASM Assembler is a full-featured, universal macro assembler for PIC10/12/16/18 MCUs.

The MPASM Assembler generates relocatable object files for the MPLINK Object Linker, Intel® standard HEX files, MAP files to detail memory usage and symbol reference, absolute LST files that contain source lines and generated machine code, and COFF files for debugging.

The MPASM Assembler features include:

- Integration into MPLAB X IDE projects
- User-defined macros to streamline assembly code
- Conditional assembly for multipurpose source files
- Directives that allow complete control over the assembly process

29.4 MPLINK Object Linker/ MPLIB Object Librarian

The MPLINK Object Linker combines relocatable objects created by the MPASM Assembler. It can link relocatable objects from precompiled libraries, using directives from a linker script.

The MPLIB Object Librarian manages the creation and modification of library files of precompiled code. When a routine from a library is called from a source file, only the modules that contain that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications.

The object linker/library features include:

- Efficient linking of single libraries instead of many smaller files
- Enhanced code maintainability by grouping related modules together
- Flexible creation of libraries with easy module listing, replacement, deletion and extraction

29.5 MPLAB Assembler, Linker and Librarian for Various Device Families

MPLAB Assembler produces relocatable machine code from symbolic assembly language for PIC24, PIC32 and dsPIC DSC devices. MPLAB XC Compiler uses the assembler to produce its object file. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. Notable features of the assembler include:

- Support for the entire device instruction set
- Support for fixed-point and floating-point data
- Command-line interface
- Rich directive set
- Flexible macro language
- MPLAB X IDE compatibility

29.6 MPLAB X SIM Software Simulator

The MPLAB X SIM Software Simulator allows code development in a PC-hosted environment by simulating the PIC MCUs and dsPIC DSCs on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a comprehensive stimulus controller. Registers can be logged to files for further run-time analysis. The trace buffer and logic analyzer display extend the power of the simulator to record and track program execution, actions on I/O, most peripherals and internal registers.

The MPLAB X SIM Software Simulator fully supports symbolic debugging using the MPLAB XC Compilers, and the MPASM and MPLAB Assemblers. The software simulator offers the flexibility to develop and debug code outside of the hardware laboratory environment, making it an excellent, economical software development tool.

29.7 MPLAB REAL ICE In-Circuit Emulator System

The MPLAB REAL ICE In-Circuit Emulator System is Microchip's next generation high-speed emulator for Microchip Flash DSC and MCU devices. It debugs and programs all 8, 16 and 32-bit MCU, and DSC devices with the easy-to-use, powerful graphical user interface of the MPLAB X IDE.

The emulator is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with either a connector compatible with in-circuit debugger systems (RJ-11) or with the new high-speed, noise tolerant, Low-Voltage Differential Signal (LVDS) interconnection (CAT5).

The emulator is field upgradable through future firmware downloads in MPLAB X IDE. MPLAB REAL ICE offers significant advantages over competitive emulators including full-speed emulation, run-time variable watches, trace analysis, complex breakpoints, logic probes, a ruggedized probe interface and long (up to three meters) interconnection cables.

29.8 MPLAB ICD 3 In-Circuit Debugger System

The MPLAB ICD 3 In-Circuit Debugger System is Microchip's most cost-effective, high-speed hardware debugger/programmer for Microchip Flash DSC and MCU devices. It debugs and programs PIC Flash microcontrollers and dsPIC DSCs with the powerful, yet easy-to-use graphical user interface of the MPLAB IDE.

The MPLAB ICD 3 In-Circuit Debugger probe is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with a connector compatible with the MPLAB ICD 2 or MPLAB REAL ICE systems (RJ-11). MPLAB ICD 3 supports all MPLAB ICD 2 headers.

29.9 PICkit 3 In-Circuit Debugger/Programmer

The MPLAB PICkit 3 allows debugging and programming of PIC and dsPIC Flash microcontrollers at a most affordable price point using the powerful graphical user interface of the MPLAB IDE. The MPLAB PICkit 3 is connected to the design engineer's PC using a full-speed USB interface and can be connected to the target via a Microchip debug (RJ-11) connector (compatible with MPLAB ICD 3 and MPLAB REAL ICE). The connector uses two device I/O pins and the Reset line to implement in-circuit debugging and In-Circuit Serial Programming™ (ICSP™).

29.10 MPLAB PM3 Device Programmer

The MPLAB PM3 Device Programmer is a universal, CE compliant device programmer with programmable voltage verification at V_{DDMIN} and V_{DDMAX} for maximum reliability. It features a large LCD display (128 x 64) for menus and error messages, and a modular, detachable socket assembly to support various package types. The ICSP cable assembly is included as a standard item. In Stand-Alone mode, the MPLAB PM3 Device Programmer can read, verify and program PIC devices without a PC connection. It can also set code protection in this mode. The MPLAB PM3 connects to the host PC via an RS-232 or USB cable. The MPLAB PM3 has high-speed communications and optimized algorithms for quick programming of large memory devices, and incorporates an MMC card for file storage and data applications.

TABLE 30-10: 96 MHz PLL CLOCK TIMING SPECIFICATIONS (VDDCORE = 2.35V TO 2.75V)

Param No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
F10	FOSC	Oscillator Frequency Range	4	—	48	MHz	
F11	FSYS	On-Chip VCO System Frequency	—	96	—	MHz	
F12	t_{rc}	PLL Start-up Time (lock time)	—	—	2	ms	

TABLE 30-11: 4x PLL CLOCK TIMING SPECIFICATIONS

Param No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
F10	FPLLIN	PLL Input Frequency Range	4	—	12	MHz	
F11	FPLLO	PLL Output Frequency (4x FPLLIN)	16	—	48	MHz	
F12	t_{rc}	PLL Start-up Time (lock time)	—	—	2	ms	

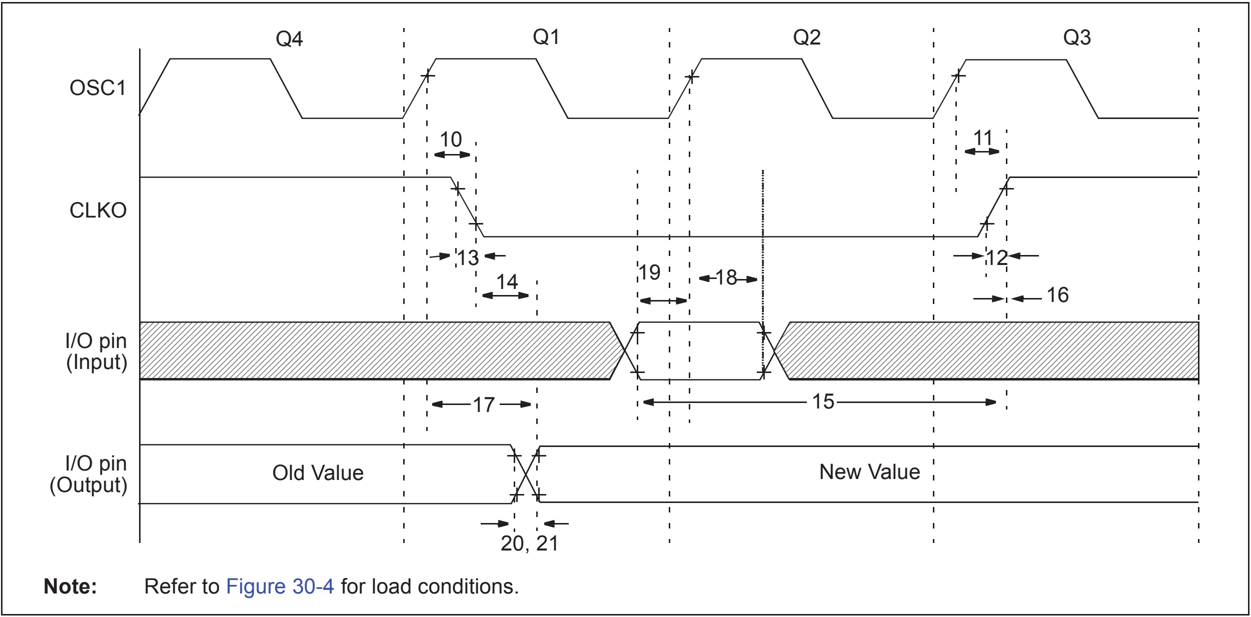
† Data in “Typ” column is at 3.3V, 25°C, unless otherwise stated. These parameters are for design guidance only and are not tested.

TABLE 30-12: INTERNAL RC ACCURACY (INTOSC AND INTRC SOURCES)

Param No.	Device	Min	Typ	Max	Units	Conditions	
	INTOSC Accuracy @ Freq = 8 MHz, 4 MHz, 2 MHz, 1 MHz, 500 kHz, 250 kHz, 125 kHz, 31 kHz(1)						
	All Devices	-1	±0.15	+1	%	0°C to +85°C	VDD = 2.4V-3.6V, VDDCORE = 2.3V-2.7V
		-1	±0.25	+1	%	-40°C to +85°C	VDD = 2.0V-3.6V, VDDCORE = 2.0V-2.7V
	INTRC Accuracy @ Freq = 31 kHz(1)						
	All Devices	20.3	—	42.2	kHz	-40°C to +85°C	VDD = 2.0V-3.6V, VDDCORE = 2.0V-2.7V

Note 1: The accuracy specification of the 31 kHz clock is determined by which source is providing it at a given time. When INTSRC (OSCTUNE<7>) is ‘1’, use the INTOSC accuracy specification. When INTSRC is ‘0’, use the INTRC accuracy specification.

FIGURE 30-6: CLKO AND I/O TIMING



Note: Refer to Figure 30-4 for load conditions.

TABLE 30-13: CLKO AND I/O TIMING REQUIREMENTS

Param No.	Symbol	Characteristic	Min	Typ	Max	Units	Conditions
10	TOSH2CKL	OSC1 ↑ to CLKO ↓	—	75	200	ns	**(Note 1)**
11	TOSH2CKH	OSC1 ↑ to CLKO ↑	—	75	200	ns	**(Note 1)**
12	TCKR	CLKO Rise Time	—	15	30	ns	**(Note 1)**
13	TCKF	CLKO Fall Time	—	15	30	ns	**(Note 1)**
14	TCKL2IOV	CLKO ↓ to Port Out Valid	—	—	0.5 TCY + 20	ns	
15	TIOV2CKH	Port In Valid before CLKO ↑	0.25 TCY + 25	—	—	ns	
16	TCKH2IOI	Port In Hold after CLKO ↑	0	—	—	ns	
17	TOSH2IOV	OSC1 ↑ (Q1 cycle) to Port Out Valid	—	50	150	ns	
18	TOSH2IOI	OSC1 ↑ (Q2 cycle) to Port Input Invalid (I/O in hold time)	100	—	—	ns	
19	TIOV2OSH	Port Input Valid to OSC1 ↑ (I/O in setup time)	0	—	—	ns	
20	TIOR	Port Output Rise Time	—	—	6	ns	
21	TIOF	Port Output Fall Time	—	—	5	ns	
22†	TINP	INTx pin High or Low Time	TCY	—	—	ns	
23†	TRBP	RB<7:4> Change INTx High or Low Time	TCY	—	—	ns	

† These parameters are asynchronous events not related to any internal clock edges.

Note 1: Measurements are taken in EC mode, where CLKO output is 4 x TOSC.